



DMN4031SSDQ

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C (Note 7)
40V	31mΩ @ V _{GS} = 10V	7.0A
	$50m\Omega @ V_{GS} = 4.5V$	5.8A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Motor Control
- Backlighting
- **Power Management Functions**
- **DC-DC Converters**

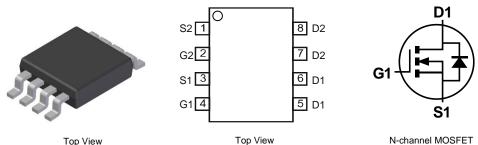
DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

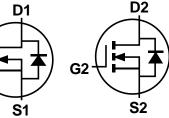
- Low On-Resistance
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.072 grams (Approximate)



SO-8



N-channel MOSFET

N-channel MOSFET

Ordering Information (Note 5)

Part Number		Case	Packaging		
DMN4031SSDQ-13		SO-8	2,500/Tape & Reel		
Notes:	Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.				

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

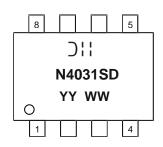
Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.

5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



∃ | = Manufacturer's Marking N4031SD = Product Type Marking Code YYWW = Date Code Marking YY or \overline{YY} = Year (ex: 18 = 2018) WW = Week (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Ch	Symbol	Value	Unit V			
Drain-Source Voltage	V _{DSS}	40				
Gate-Source Voltage				V _{GSS}	±20	V
Continuous Drain Current (Note 6)	$V_{GS} = 10V$	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	5.2 4.1	А
Continuous Drain Current (Note 6)	$V_{GS} = 4.5V$	Steady State	T _A = +25°C T _A = +70°C	I _D	4.3 3.4	А
Continuous Drain Current (Note 7)	$V_{GS} = 10V$	Steady State	T _A = +25°C T _A = +70°C	ID	7.0 5.6	A
Continuous Drain Current (Note 7)	$V_{GS} = 4.5V$	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	5.8 4.7	A
Pulsed Drain Current (Note 8)				I _{DM}	20	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 6)	PD	1.42	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 6)	R _{θJA}	88	°C/W
Total Power Dissipation (Note 7)	PD	2.6	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 7)	R _{θJA}	48	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	40	—	—	V	$V_{GS} = 0V, I_D = 10mA$	
Zero Gate Voltage Drain Current	I _{DSS}		—	1	μA	$V_{DS} = 40V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	1.6	2.4	3.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
On-State Drain Current	I _{D(ON)}	20	_	-	Α	$V_{GS} = 10V, V_{DS} = 5A$	
Static Drain-Source On-Resistance	D	_	19	31		$V_{GS} = 10V, I_D = 6A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	—	44	50	mΩ	$V_{GS} = 4.5V, I_D = 5A$	
Forward Transfer Admittance	Y _{fs}	_	11	—	S	$V_{DS} = 5V, I_D = 6A$	
Diode Forward Voltage	V _{SD}	_	0.74	1.0	V	$V_{GS} = 0V, I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss		945	—	pF		
Output Capacitance	Coss	-	69	-	pF	$V_{DS} = 20V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance	Crss	-	58	-	pF		
Gate Resistance	R _g		1.45	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	-	8.4	-	nC	V _{GS} = 4.5V, V _{DS} = 20V, I _D = 12A	
Total Gate Charge (V _{GS} = 10V)	Qg	_	18.6	—	nC		
Gate-Source Charge	Q _{qs}	_	3.3	—	nC	nC V _{GS} = 10V, V _{DS} = 20V, I _D = 12A	
Gate-Drain Charge	Q _{gd}	_	2.2	—	nC		
Turn-On Delay Time	t _{D(ON)}	_	6.4	—	ns		
Turn-On Rise Time	t _R	_	9.7	—	ns	$V_{GS} = 10V, V_{DS} = 20V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	19.8	—	ns R_L = 1.6Ω, R_G = 3Ω ns		
Turn-Off Fall Time	tF	_	3.1	—			

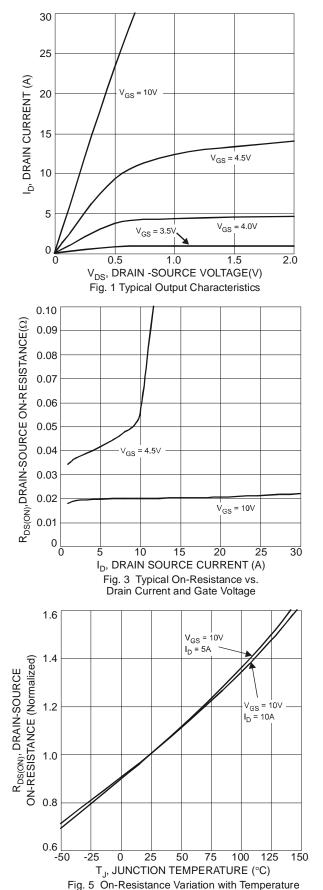
 Device mounted on FR-4 PCB, with minimum recommended pad layout. The value in any given application depends on user's specific board design.
Device mounted on 1" x 1" FR-4 PCB with high coverage 1 oz. Copper, single sided.
Repetitive rating, pulse width limited by junction temperature. Notes:

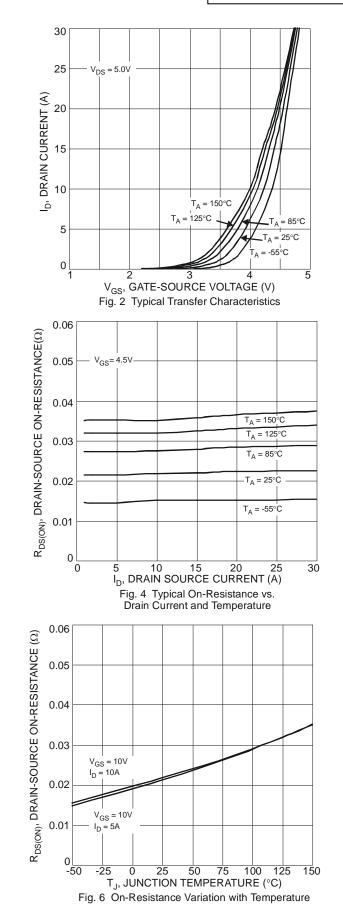
9. Short duration pulse test used to minimize self-heating effect

10. Guaranteed by design. No subject to production testing.

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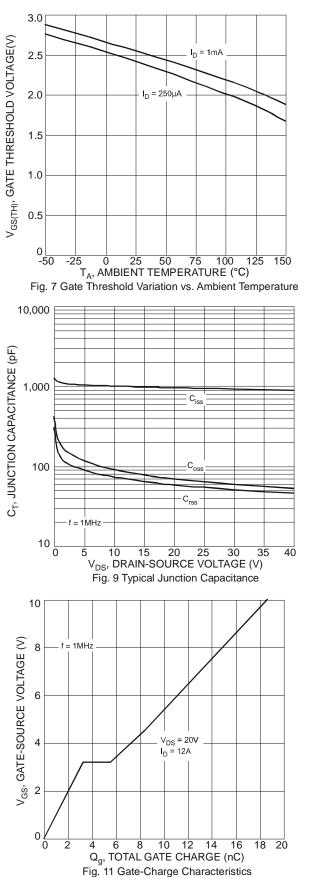


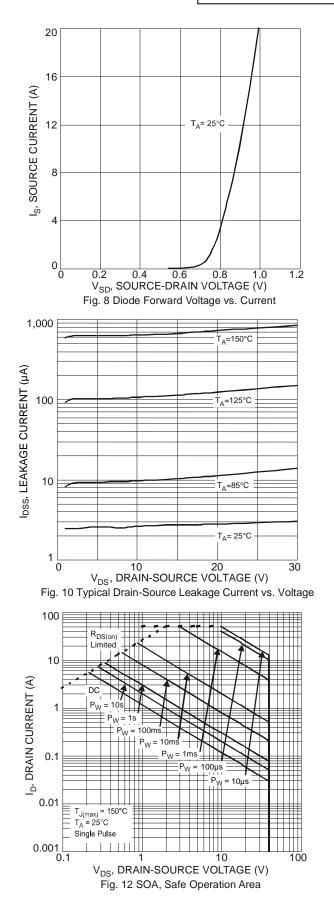




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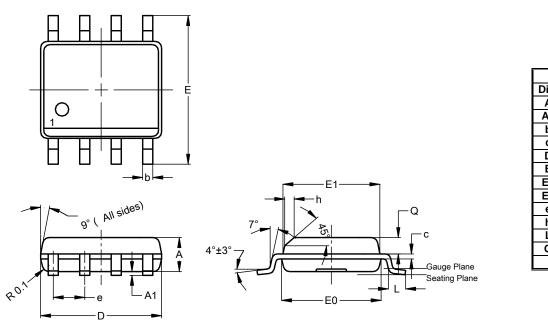






Package Outline Dimensions

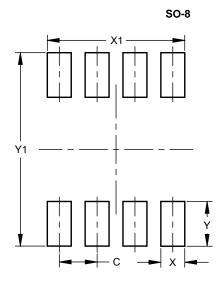
Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8					
Dim	Min Max Typ		Тур		
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
е			1.27		
h	-		0.35		
L	0.62	0.82	0.72		
Q	0.60	0.70	0.65		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Y	1.505
Y1	6.50



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